



REV.	ECN NO.	REVISED	DATE

NOTE:

1.MATERIAL:

a.HOUSING:PA66

b.CONTACT:PHOSPHOR BRONZE

(SURFACE PLATING: Sn100u"-120U")

SEE ORDERING INFORMATION

2.ELECTRIC:

a.CONTACT RESISTANCE: 50 MILLIOHMS MAX

b.INSULATION RESISTANCE: 100 MEGA OHMS MIN

c.DIELECTNIC VOLTAGE: 500V AC ONE SEC LEVEL

d.OPERATING TEMPERATURE: -25° C~ +85° C

ORDERING INFORMATION

BS-02-A***007

电池座系列

BS-02系列

DIP 90° TYPE

PLATING:

A-Au1U"

J-Ni100U"~120U"

K-Sn100U"~120U"

MATERIAL:

1A-PBT BLACK

1B-PA66 BLACK

2A-PPA BROWN

2B-PPA BLACK

3A-PPS BROWN

3B-PPS BLACK

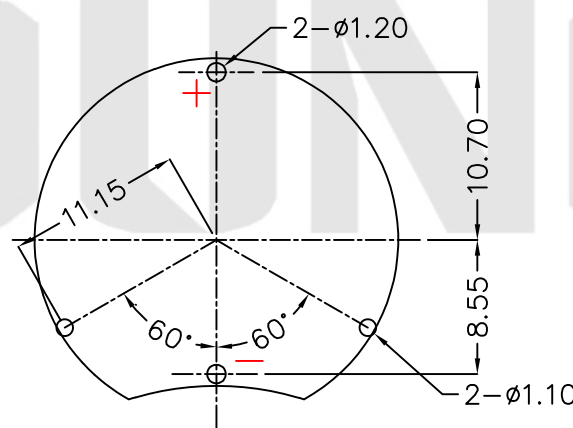
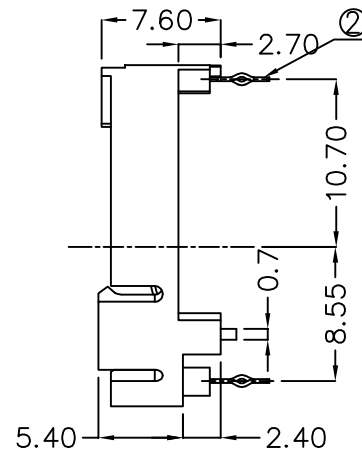
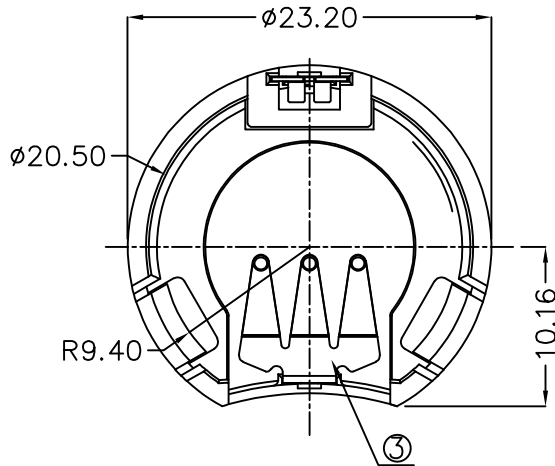
4A-LCP WHITE

4B-LCP BLACK

工程部

2018-10-10

LQ HUNAG



PCB Layout Diagram
Top View

3	TERMINAL(-)	1	PHOSPHOR BRONZE, T=0.25mm	Sn-Plating
2	TERMINAL(+)	1	PHOSPHOR BRONZE, T=0.25mm	Sn-Plating
1	HOUSING	1	PA66 15%GF	BLACK
NO.	PART NAME	Q'TY	MATERIAL	PLATING & COLOR

UNLESS OTHERWISE SPECIFIED TOLERANCES		MYOUNG 美用 www.meiyangdz.com			
DECIMALS:	ANGLES:	DSND	YangFeng	DATE	2018-08-02
X :±0.30	X :±1°	CHKD	ZhouRuicai	DATE	2018-08-02
X.X :±0.25	X.X :±0.5°	APVD	XueShunyang	DATE	2018-08-02
X.XX :±0.20		WEIGHT:	SCALE:	SIZE: A4	VIEW: ① ②
X.XXX :±0.10		SHEET 1 OF 1	UNIT: mm	REV.: A/0	OBJECT: MY
		TITLE:		PART NO.:	
		电池座BS-2032-2 DIP		BS-02-A1BK007	
		DRAW NO.:MY-CP-0137			